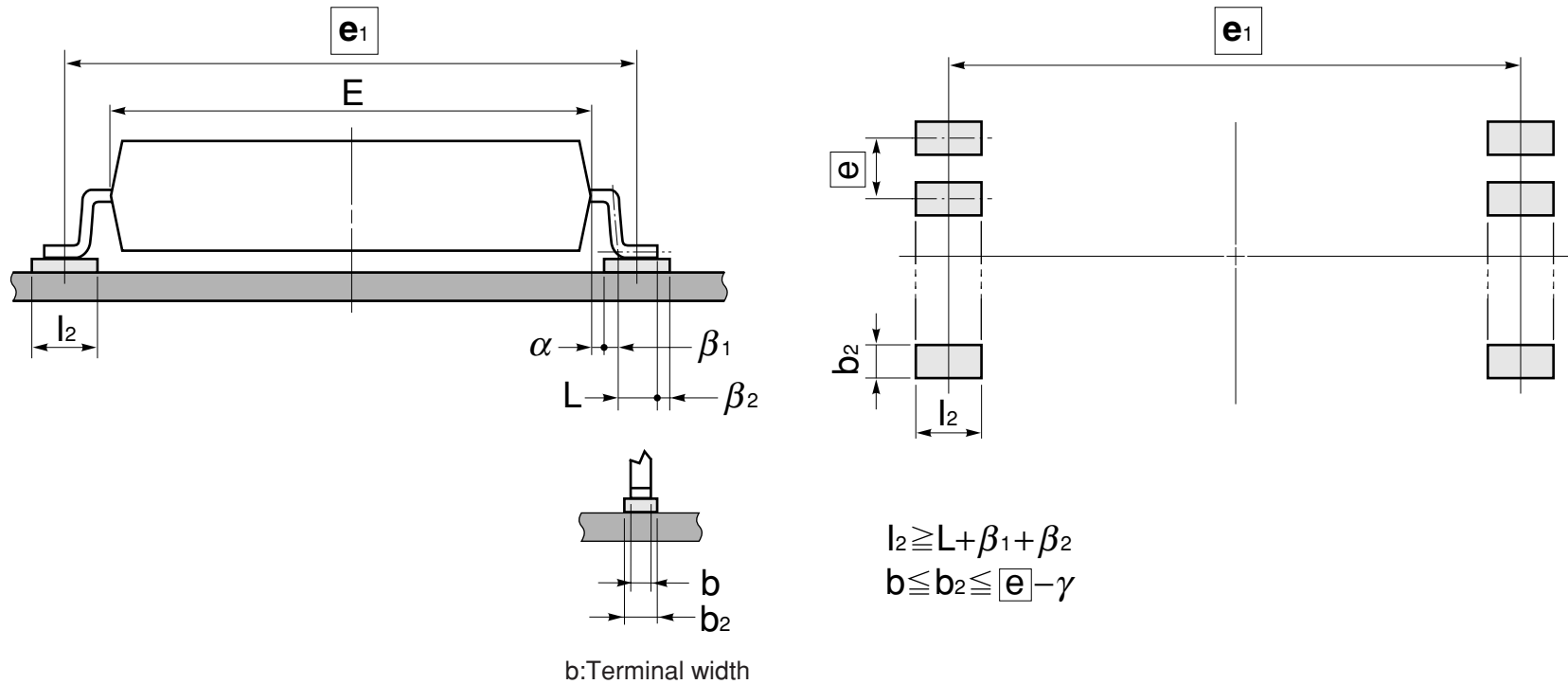


SSOP LAND PATTERN DIMENSIONS



Dimension Parameter

(Unit : mm)

e	0.80	0.65	0.5	Remark
α	0.2	0.2	0.2	Washability of the printed-circuit board
β_1	0.3	0.3	0.3	Soldering strength
β_2	0.2	0.2	0.2	Pattern accuracy of the solder mask and visual inspection soldering.
γ	0.3	0.3	0.25	Determined by the margin of safety taken into consideration as a measure for coping with the soldering bridge.

(The reference value according to EIAJ ED-7402-2 (discontinued version))